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Model	No.:
Date /	Rev.

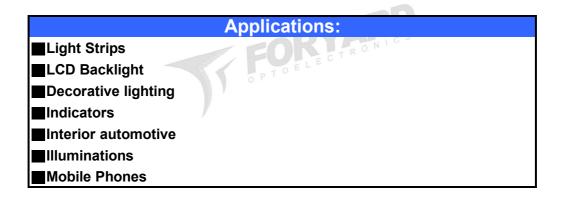
FYLP-3W-UWS30 2020.08.22/ A

PRODUCT SPECIFICATION

Model No.: FYLP-3W-UWS30

Features:

SMD Type	
Size (mm):14.40*8.00*6.30	
Emitting Color: White.	
Lens Type: Water clear.	
SMT package	
RoHS Compliant	
MSL:6	





CUSTOMER APPROVED SIGNATURES	APPROVED BY	CHECKED BY	PREPARED BY

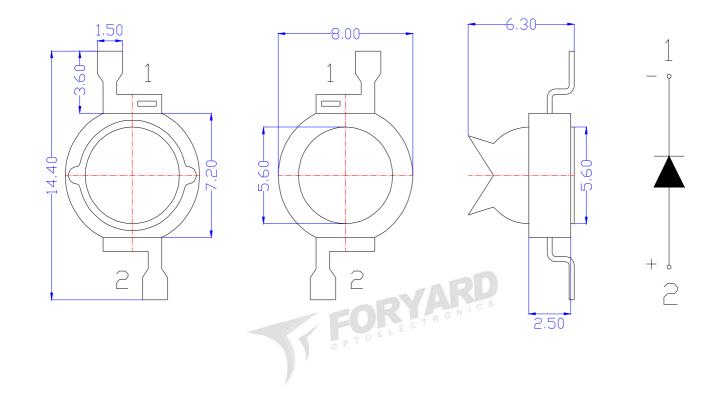
NINGBO FORYARD OPTOELECTRONICS CO., LTD.

Add:No. 666 Jinghua Road, Hi-tech Park, Ningbo, Zhejiang, China Tel: 0086-574-87933652 87927870 87922206 Fax: 0086-574-87927917 E-mail:Sales@foryard.com (General) Zip:315103

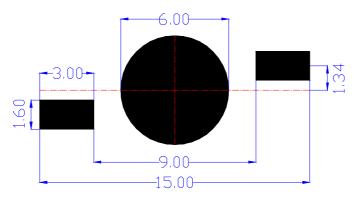


Model No.:	FYLP-3W-UWS30	
Date / Rev.	2020.08.22/ A	

Mechanical Dimensions



Recommend Soldering pad design(unit=mm)



Notes:

1. Dimension in millimeter, tolerance is ± 0.10 .

2.Angle:±5°

3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

4. The drawing is different from the actual one, please refer to the sample.



Model No.:	FYLP-3W-UWS30
Date / Rev.	2020.08.22/ A

■ Absolute Maximun Ratings(Ta=25°C)

Parameter	Symbol	MAX.	Unit
Power Dissipation	PD	3000	mW
Peak Forward Current*	IFP	800	mA
Continuous Forward Current	IF	800	mA
Reverse Voltage	VR	5	V
Operating Temperature Range	Topr	-20~ +75	°C
Storage Temperature Range	Tstg	-40~ +100	°C

*1/10 Duty Cycle, 0.1ms Pulse Width

■ Typical Electrical &Optical Charcteristics(Ta=25°C)

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Forward Voltage	V _F	IF=800mA	2.8	3	3.6	V
Reverse Current	I _R	VR=5V			10	μA
Chromaticity coordinates	Х	IF=800mA		0.465		
	Y	IF=800mA		0.465		
Color temperature	ССТ	IF=800mA	2800		3200	К
Luminous Flux	l _v	IF=800mA	220		260	Lm
Color Rendering Index	Ra	● F=800mA		80		
Viewing Angle	2θ _{1/2}	IF=800mA		120		Deg

Material

Item	Reflector	Wire	Encapsulate	Chip
Material	PPA	Gold	Silicone	InGaN/GaN

Note:

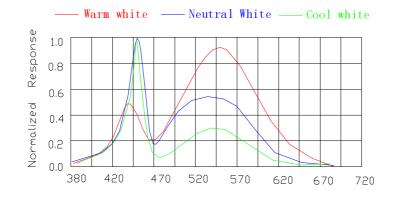
1.Luminous Intensity is based on the Foryard standards.

2.Pay attention about static for InGaN



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Date / Rev.	2020.08.22/ A

Electrical-Optical Characteristics-



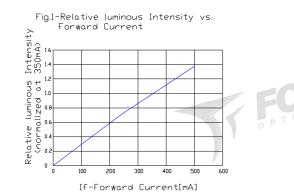


Fig.2-Forward Current vs. Forward Voltage

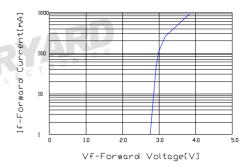


Fig.3-Relative Intensity(@350mA) vs. Ambient Temperature

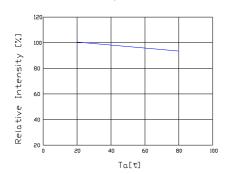
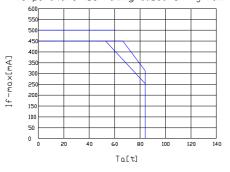
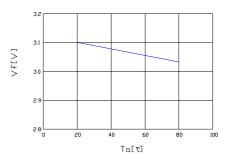


Fig.5-Maximum Driving Forward DC Current vs. Ambient Temperature (De-rating based on Tj max.=1250)

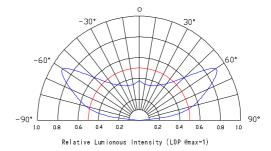


NOTE:25°C free air temperature unless otherwise specified





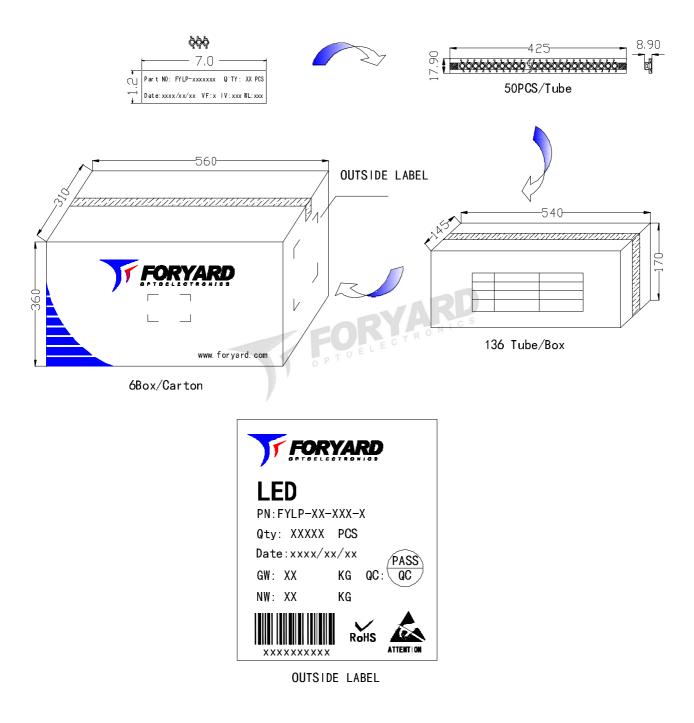






Model No.:	FYLP-3W-UWS30	
Date / Rev.	2020.08.22/ A	

Package-



Notice:

- 1.Quantity:50 PCS/Tube
- 2.Tolerance unless mentioned is $\pm 0.2 \text{mm}$
- 3. The specifications are subject to change without notice. Please contact us for updated information.



Model No.:	FYLP-3W-UWS30
Date / Rev.	2020.08.22/ A

■ Handling of Silicone Resin LEDs-

Handling Indications

When handling the product, do not touch it directly with bare hands as it may contaminate the surface and affect on optica characteristics. In the worst cases, excessive force to the product might result in catastrophic failure due to package damage and/or wire breakage.

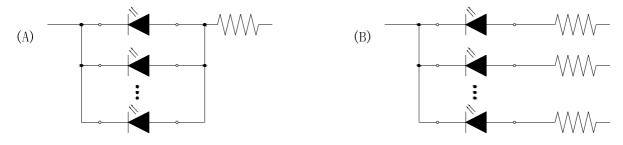


When handling the product with tweezers, LEDs should only be handled from the side and make sure that excessive force is not applied to the resin portion of the pordct. Failure to comply can cause the resin portion of the product to be cut, chipped, delaminated and/or deformed, and wire to be broken, and thus resulting in catastrophic failure.



Recommended circuit-

• In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LEC It is recommended to use Circuit B which regulates the current flowing through each LED. In the meanwhile, when driving LE with a constant voltage in Circuit A, the current through the LEDs may vary due to the variation in forward voltage(VF) of the LEDs. In the worst case, some LED may be subjected to stresses in excess of the absolute maximum rating.



• This product should be operated in forward bias. A driving circuit must be designed so that the product is not subjected to either forward or reverse voltage while it is off. In particular, if a reverse voltage is continuously applied to the product; such operation can cause migration resulting in LED damage.

Storage-

Storage Conditions

1. Unopened moisture barrier bag (MBB) shall be stored at temperature below $5^{\circ}C \sim 30^{\circ}C$, with humidity below $60^{\circ}RH$. 2. Before the MBB be opened, check if have the air leakage, if have, then need to bake at $65^{\circ}C \sim 70^{\circ}C$ for 24 hours.

- 3.After the MBB has been opened, the LEDs which need for reflow soldering or other soldering methods, must be used according to below:
 - a: Must finish the soldering in 12hours
 - b: Stored with the humidity below 30%RH
 - c: If not finish the soldering in 12hours, need to bake the LED again at $65\,^\circ\!C$ ~70 $^\circ\!C$ for 24hours